

### FEATURES

**Low on resistance (300  $\Omega$  typical)**  
**Fast switching times**  
 $t_{ON}$  250 ns maximum  
 $t_{OFF}$  250 ns maximum  
**Low power dissipation (3.3 mW maximum)**  
**Fault and overvoltage protection (–40 V to +55 V)**  
**All switches off with power supply off**  
**Analog output of on channel clamped within power supplies if an overvoltage occurs**  
**Latch-up proof construction**  
**Break-before-make construction**  
**TTL and CMOS compatible inputs**

### APPLICATIONS

**Existing multiplexer applications (both fault-protected and nonfault-protected)**  
**New designs requiring multiplexer functions**

### GENERAL DESCRIPTION

The ADG508F, ADG509F, and ADG528F are CMOS analog multiplexers, with the ADG508F and ADG528F comprising eight single channels and the ADG509F comprising four differential channels. These multiplexers provide fault protection. Using a series n-channel, p-channel, n-channel MOSFET structure, both device and signal source protection is provided in the event of an overvoltage or power loss. The multiplexer can withstand continuous overvoltage inputs from –40 V to +55 V. During fault conditions, the multiplexer input (or output) appears as an open circuit and only a few nanoamperes of leakage current will flow. This protects not only the multiplexer and the circuitry driven by the multiplexer, but also protects the sensors or signal sources that drive the multiplexer.

The ADG508F and ADG528F switch one of eight inputs to a common output as determined by the 3-bit binary address lines A0, A1, and A2. The ADG509F switches one of four differential inputs to a common differential output as determined by the 2-bit binary address lines A0 and A1. The ADG528F has on-chip address and control latches that facilitate microprocessor

### FUNCTIONAL BLOCK DIAGRAMS

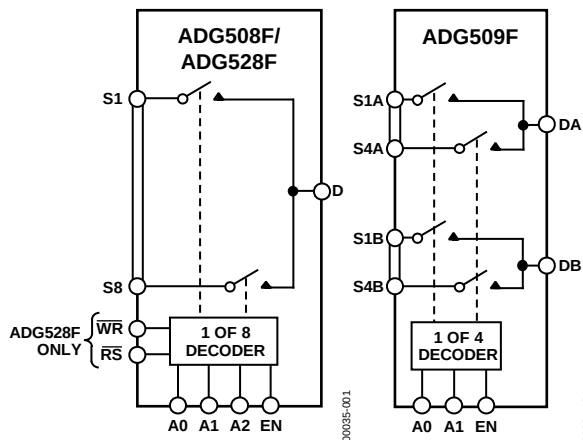


Figure 1.

interfacing. An EN input on each device is used to enable or disable the device. When disabled, all channels are switched off.

### PRODUCT HIGHLIGHTS

- Fault Protection.**  
The ADG508F/ADG509F/ADG528F can withstand continuous voltage inputs from –40 V to +55 V. When a fault occurs due to the power supplies being turned off, all the channels are turned off and only a leakage current of a few nanoamperes flows.
- On channel turns off while fault exists.
- Low  $R_{ON}$ .
- Fast switching times.
- Break-before-make switching.  
Switches are guaranteed break-before-make so that input signals are protected against momentary shorting.
- Trench isolation eliminates latch-up.  
A dielectric trench separates the p and n-channel MOSFETs thereby preventing latch-up.

#### Rev. E

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REVISION HISTORY

7/09—Rev. D: Rev. E

|                                  |           |
|----------------------------------|-----------|
| Updated Format .....             | Universal |
| Added TSSOP .....                | Universal |
| Updated Outline Dimensions ..... | 15        |
| Changes to Ordering Guide .....  | 18        |

4/01—Data Sheet Changed from Rev. C to Rev. D.

|                                                      |    |
|------------------------------------------------------|----|
| Changes to Ordering Guide .....                      | 1  |
| Changes to Specifications Table.....                 | 2  |
| Max Ratings Changed .....                            | 4  |
| Deleted 16-Lead Cerdip from Outline Dimensions ..... | 11 |
| Deleted 18-Lead Cerdip from Outline Dimensions ..... | 12 |

# SPECIFICATIONS

## DUAL SUPPLY

$V_{DD} = +15\text{ V} \pm 10\%$ ,  $V_{SS} = -15\text{ V} \pm 10\%$ , GND = 0 V, unless otherwise noted.

Table 1.

| Parameter                                          | +25°C                  | B Version<br>–40°C to +85°C    | Unit                                   | Test Conditions/Comments                                                                                                                 |
|----------------------------------------------------|------------------------|--------------------------------|----------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------|
| ANALOG SWITCH                                      |                        |                                |                                        |                                                                                                                                          |
| Analog Signal Range                                |                        | $V_{SS} + 3$<br>$V_{DD} - 1.5$ | V min<br>V max                         |                                                                                                                                          |
| $R_{ON}$                                           | 300                    | 350                            | $\Omega$ typ                           | $-10\text{ V} \leq V_S \leq +10\text{ V}$ , $I_S = 1\text{ mA}$ ;<br>$V_{DD} = +15\text{ V} \pm 10\%$ , $V_{SS} = -15\text{ V} \pm 10\%$ |
|                                                    |                        | 400                            | $\Omega$ max                           | $-10\text{ V} \leq V_S \leq +10\text{ V}$ , $I_S = 1\text{ mA}$ ;<br>$V_{DD} = +15\text{ V} \pm 5\%$ , $V_{SS} = -15\text{ V} \pm 5\%$   |
| $R_{ON}$ Drift                                     | 0.6                    |                                | %/°C typ                               | $V_S = 0\text{ V}$ , $I_S = 1\text{ mA}$                                                                                                 |
| $R_{ON}$ Match                                     | 5                      |                                | % max                                  | $V_S = 0\text{ V}$ , $I_S = 1\text{ mA}$                                                                                                 |
| LEAKAGE CURRENTS                                   |                        |                                |                                        |                                                                                                                                          |
| Source OFF Leakage $I_S$ (OFF)                     | $\pm 0.02$<br>$\pm 1$  | $\pm 50$                       | nA typ<br>nA max                       | $V_D = \pm 10\text{ V}$ , $V_S = \mp 10\text{ V}$ ;<br>See Figure 22                                                                     |
| Drain OFF Leakage $I_D$ (OFF)                      | $\pm 0.04$<br>$\pm 1$  | $\pm 60$                       | nA typ<br>nA max                       | $V_D = \pm 10\text{ V}$ , $V_S = \mp 10\text{ V}$ ;<br>See Figure 23                                                                     |
| ADG508F/ADG528F                                    | $\pm 1$                | $\pm 60$                       | nA max                                 |                                                                                                                                          |
| ADG509F                                            | $\pm 1$                | $\pm 30$                       | nA max                                 |                                                                                                                                          |
| Channel ON Leakage $I_D$ , $I_S$ (ON)              | $\pm 0.04$<br>$\pm 1$  | $\pm 60$                       | nA typ<br>nA max                       | $V_S = V_D = \pm 10\text{ V}$ ;<br>See Figure 24                                                                                         |
| ADG508F/ADG528F                                    | $\pm 1$                | $\pm 60$                       | nA max                                 |                                                                                                                                          |
| ADG509F                                            | $\pm 1$                | $\pm 30$                       | nA max                                 |                                                                                                                                          |
| FAULT                                              |                        |                                |                                        |                                                                                                                                          |
| Output Leakage Current<br>(With Overvoltage)       | $\pm 0.02$<br>$\pm 2$  | $\pm 2$                        | nA typ<br>$\mu\text{A}$ max            | $V_S = \pm 33\text{ V}$ , $V_D = 0\text{ V}$ , see Figure 23                                                                             |
| Input Leakage Current<br>(With Overvoltage)        | $\pm 0.005$<br>$\pm 2$ |                                | $\mu\text{A}$ typ<br>$\mu\text{A}$ max | $V_S = \pm 25\text{ V}$ , $V_D = \mp 10\text{ V}$ , see Figure 25                                                                        |
| Input Leakage Current<br>(With Power Supplies OFF) | $\pm 0.001$<br>$\pm 2$ |                                | $\mu\text{A}$ typ<br>$\mu\text{A}$ max | $V_S = \pm 25\text{ V}$ , $V_D = V_{EN} = A0, A1, A2 = 0\text{ V}$<br>See Figure 26                                                      |
| DIGITAL INPUTS                                     |                        |                                |                                        |                                                                                                                                          |
| Input High Voltage, $V_{INH}$                      |                        | 2.4                            | V min                                  |                                                                                                                                          |
| Input Low Voltage, $V_{INL}$                       |                        | 0.8                            | V max                                  |                                                                                                                                          |
| Input Current, $I_{INL}$ or $I_{INH}$              |                        | $\pm 1$                        | $\mu\text{A}$ max                      | $V_{IN} = 0$ or $V_{DD}$                                                                                                                 |
| $C_{IN}$ , Digital Input Capacitance               | 5                      |                                | pF typ                                 |                                                                                                                                          |
| DYNAMIC CHARACTERISTICS <sup>1</sup>               |                        |                                |                                        |                                                                                                                                          |
| $t_{TRANSITION}$                                   | 200<br>300             | 400                            | ns typ<br>ns max                       | $R_L = 1\text{ M}\Omega$ , $C_L = 35\text{ pF}$ ;<br>$V_{S1} = \pm 10\text{ V}$ , $V_{S8} = \mp 10\text{ V}$ ; see Figure 27             |
| $t_{OPEN}$                                         | 50<br>25               | 10                             | ns typ<br>ns min                       | $R_L = 1\text{ k}\Omega$ , $C_L = 35\text{ pF}$ ;<br>$V_S = 5\text{ V}$ ; see Figure 28                                                  |
| $t_{ON}$ (EN, $\overline{WR}$ )                    | 200<br>250             | 400                            | ns typ<br>ns max                       | $R_L = 1\text{ k}\Omega$ , $C_L = 35\text{ pF}$ ;<br>$V_S = 5\text{ V}$ ; see Figure 29                                                  |
| $t_{OFF}$ (EN, $\overline{RS}$ )                   | 200                    |                                | ns typ                                 | $R_L = 1\text{ k}\Omega$ , $C_L = 35\text{ pF}$ ;                                                                                        |
| $t_{SETT}$ , Settling Time                         | 250                    | 400                            | ns max                                 | $V_S = 5\text{ V}$ ; see Figure 29                                                                                                       |
| 0.1%                                               |                        | 1                              | $\mu\text{s}$ typ                      | $R_L = 1\text{ k}\Omega$ , $C_L = 35\text{ pF}$ ;                                                                                        |
| 0.01%                                              |                        | 2.5                            | $\mu\text{s}$ typ                      | $V_S = 5\text{ V}$                                                                                                                       |
| ADG528F Only                                       |                        |                                |                                        |                                                                                                                                          |
| $t_W$ , Write Pulse Width                          | 100                    | 120                            | ns min                                 |                                                                                                                                          |
| $t_S$ , Address, Enable Setup Time                 |                        | 100                            | ns min                                 |                                                                                                                                          |
| $t_H$ , Address, Enable Hold Time                  |                        | 10                             | ns min                                 |                                                                                                                                          |
| $t_{RS}$ , Reset Pulse Width                       |                        | 100                            | ns min                                 |                                                                                                                                          |

# ADG508F/ADG509F/ADG528F

| Parameter          | B Version |                | Unit   | Test Conditions/Comments                                                                                                                                                                           |
|--------------------|-----------|----------------|--------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                    | +25°C     | –40°C to +85°C |        |                                                                                                                                                                                                    |
| Charge Injection   | 4         |                | pC typ | $V_S = 0\text{ V}$ , $R_S = 0\ \Omega$ , $C_L = 1\text{ nF}$ ; see Figure 32<br>$R_L = 1\text{ k}\Omega$ , $C_L = 15\text{ pF}$ , $f = 100\text{ kHz}$ ;<br>$V_S = 7\text{ V rms}$ ; see Figure 33 |
| OFF Isolation      | 68        |                | dB typ |                                                                                                                                                                                                    |
|                    | 50        |                | dB min |                                                                                                                                                                                                    |
| $C_S$ (OFF)        | 5         |                | pF typ |                                                                                                                                                                                                    |
| $C_D$ (OFF)        |           |                |        |                                                                                                                                                                                                    |
| ADG508F/ADG528F    | 50        |                | pF typ |                                                                                                                                                                                                    |
| ADG509F            | 25        |                | pF typ |                                                                                                                                                                                                    |
| POWER REQUIREMENTS |           |                |        |                                                                                                                                                                                                    |
| $I_{DD}$           | 0.1       | 0.2            | mA max | $V_{IN} = 0\text{ V or }5\text{ V}$                                                                                                                                                                |
| $I_{SS}$           | 0.1       | 0.1            | mA max |                                                                                                                                                                                                    |

<sup>1</sup> Guaranteed by design, not subject to production test.

## TRUTH TABLES

Table 2. ADG508F Truth Table

| A2 | A1 | A0 | EN | ON Switch |
|----|----|----|----|-----------|
| X  | X  | X  | 0  | None      |
| 0  | 0  | 0  | 1  | 1         |
| 0  | 0  | 1  | 1  | 2         |
| 0  | 1  | 0  | 1  | 3         |
| 0  | 1  | 1  | 1  | 4         |
| 1  | 0  | 0  | 1  | 5         |
| 1  | 0  | 1  | 1  | 6         |
| 1  | 1  | 0  | 1  | 7         |
| 1  | 1  | 1  | 1  | 8         |

X = Don't Care

Table 3. ADG509F Truth Table

| A1 | A0 | EN | ON Switch Pair |
|----|----|----|----------------|
| X  | X  | 0  | None           |
| 0  | 0  | 1  | 1              |
| 0  | 1  | 1  | 2              |
| 1  | 0  | 1  | 3              |
| 1  | 1  | 1  | 4              |

X = Don't Care

Table 4. ADG528F Truth Table

| A2 | A1 | A0 | EN | WR | RS | ON Switch                                 |
|----|----|----|----|----|----|-------------------------------------------|
| X  | X  | X  | X  | 1  | 1  | Retains previous switch condition         |
| X  | X  | X  | X  | X  | 0  | None (address and enable latches cleared) |
| X  | X  | X  | 0  | 0  | 1  | None                                      |
| 0  | 0  | 0  | 1  | 0  | 1  | 1                                         |
| 0  | 0  | 1  | 1  | 0  | 1  | 2                                         |
| 0  | 1  | 0  | 1  | 0  | 1  | 3                                         |
| 0  | 1  | 1  | 1  | 0  | 1  | 4                                         |
| 1  | 0  | 0  | 1  | 0  | 1  | 5                                         |
| 1  | 0  | 1  | 1  | 0  | 1  | 6                                         |
| 1  | 1  | 0  | 1  | 0  | 1  | 7                                         |
| 1  | 1  | 1  | 1  | 0  | 1  | 8                                         |

X = Don't Care



## ABSOLUTE MAXIMUM RATINGS

T<sub>A</sub> = +25°C unless otherwise noted.

Table 5.

| Parameter                                                    | Rating                                                           |
|--------------------------------------------------------------|------------------------------------------------------------------|
| V <sub>DD</sub> to V <sub>SS</sub>                           | 44 V                                                             |
| V <sub>DD</sub> to GND                                       | −0.3 V to +25 V                                                  |
| V <sub>SS</sub> to GND                                       | +0.3 V to −25 V                                                  |
| Digital Input, EN, Ax                                        | −0.3 V to V <sub>DD</sub> + 2 V or 20 mA, whichever occurs first |
| V <sub>S</sub> , Analog Input Overvoltage with Power On      | V <sub>SS</sub> − 25 V to V <sub>DD</sub> + 40 V                 |
| V <sub>S</sub> , Analog Input Overvoltage with Power Off     | −40 V to +55 V                                                   |
| Continuous Current, S or D                                   | 20 mA                                                            |
| Peak Current, S or D<br>(Pulsed at 1 ms, 10% Duty Cycle Max) | 40 mA                                                            |
| Operating Temperature Range<br>Industrial (B Version)        | −40°C to +85°C                                                   |
| Storage Temperature Range                                    | −65°C to +150°C                                                  |
| Junction Temperature                                         | 150°C                                                            |
| TSSOP                                                        |                                                                  |
| θ <sub>JA</sub> , Thermal Impedance                          | 112°C/W                                                          |
| Plastic Package                                              |                                                                  |
| θ <sub>JA</sub> , Thermal Impedance                          |                                                                  |
| 16-Lead                                                      | 117°C/W                                                          |
| 18-Lead                                                      | 110°C/W                                                          |
| Lead Temperature, Soldering (10 sec)                         | 260°C                                                            |
| SOIC Package                                                 |                                                                  |
| θ <sub>JA</sub> , Thermal Impedance                          |                                                                  |
| Narrow Body                                                  | 77°C/W                                                           |
| Wide Body                                                    | 75°C/W                                                           |
| Lead Temperature, Soldering                                  |                                                                  |
| Vapor Phase (60 sec)                                         | 215°C                                                            |
| Infrared (15 sec)                                            | 220°C                                                            |
| PLCC Package                                                 |                                                                  |
| θ <sub>JA</sub> , Thermal Impedance                          | 90°C/W                                                           |
| Lead Temperature, Soldering                                  |                                                                  |
| Vapor Phase (60 sec)                                         | 215°C                                                            |
| Infrared (15 sec)                                            | 220°C                                                            |

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

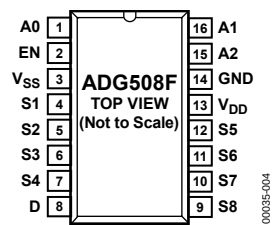


Figure 4. ADG508F Pin Configuration  
TSSOP/DIP/SOIC

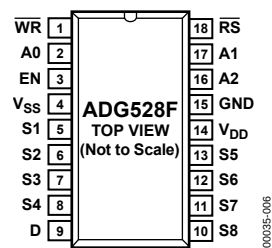


Figure 6. ADG528F Pin Configuration  
DIP

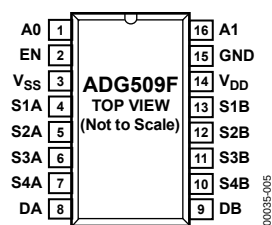


Figure 5. ADG509F Pin Configuration  
TSSOP/DIP/SOIC

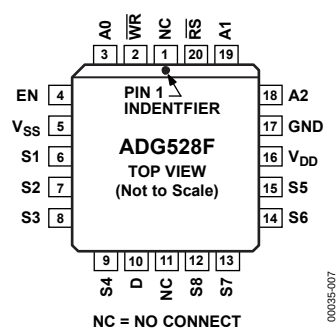


Figure 7. ADG528F Pin Configuration  
PLCC

## TYPICAL PERFORMANCE CHARACTERISTICS

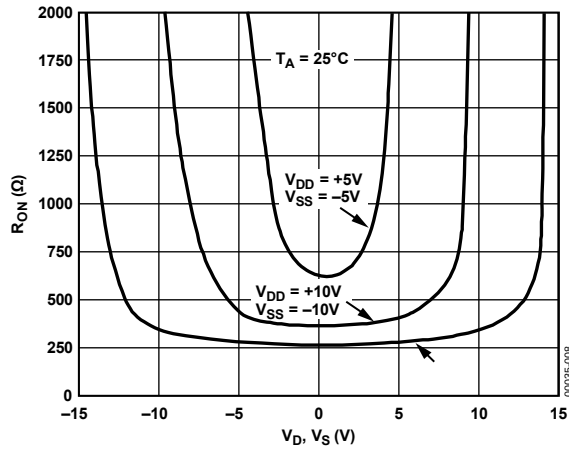


Figure 8. On Resistance as a Function of  $V_D$  ( $V_S$ )

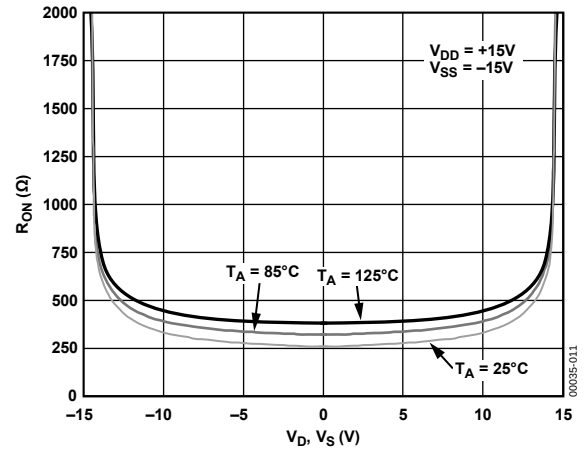


Figure 11. On Resistance as a Function of  $V_D$  ( $V_S$ ) for Different Temperatures

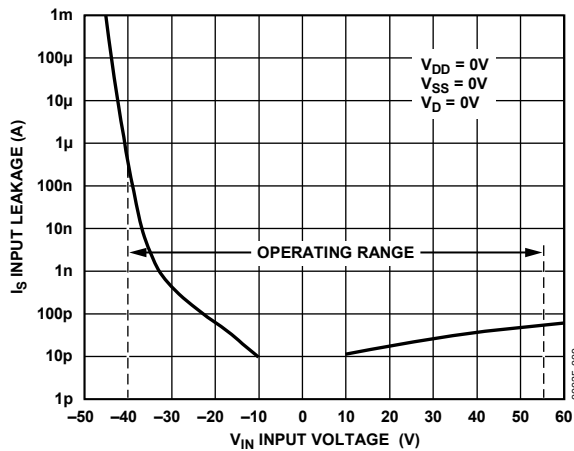


Figure 9. Input Leakage Current as a Function of  $V_S$  (Power Supplies Off) During Overvoltage Conditions

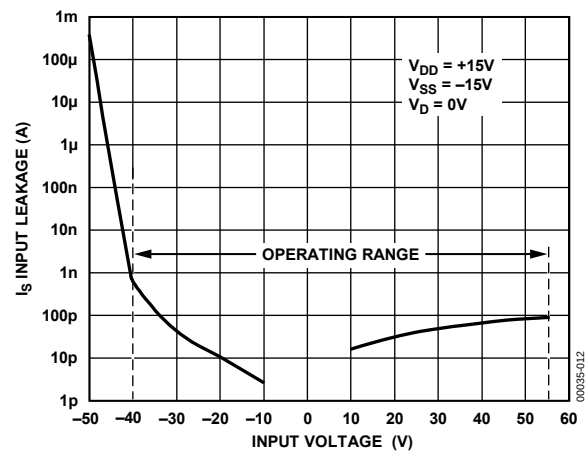


Figure 12. Input Leakage Current as a Function of  $V_S$  (Power Supplies On) During Overvoltage Conditions

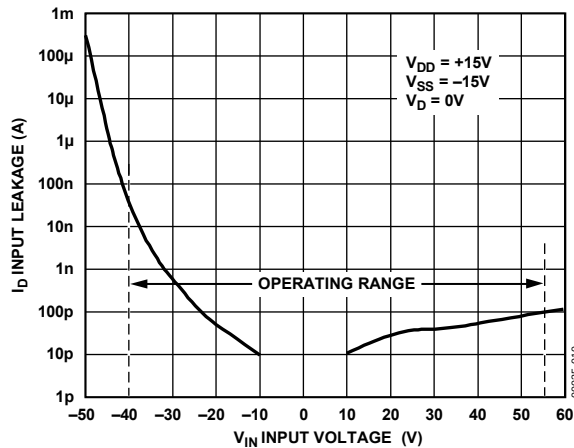


Figure 10. Output Leakage Current as a Function of  $V_S$  (Power Supplies On) During Overvoltage Conditions

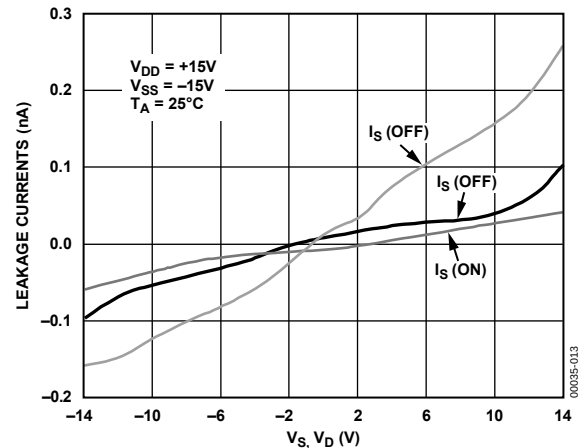


Figure 13. Leakage Currents as a Function of  $V_D$  ( $V_S$ )

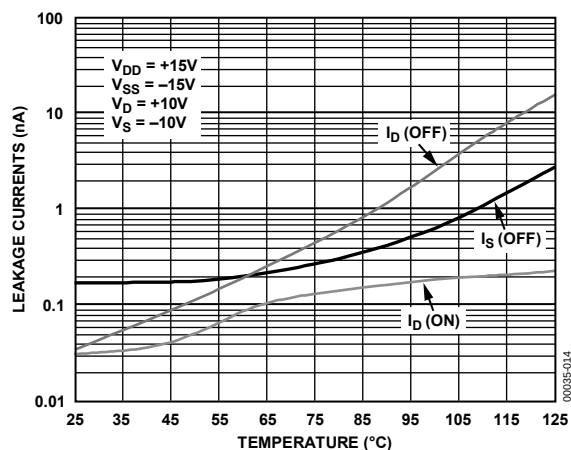


Figure 14. Leakage Currents as a Function of Temperature

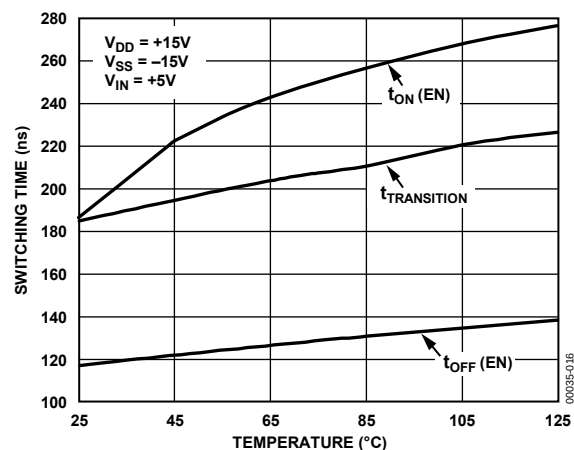


Figure 16. Switching Time vs. Temperature

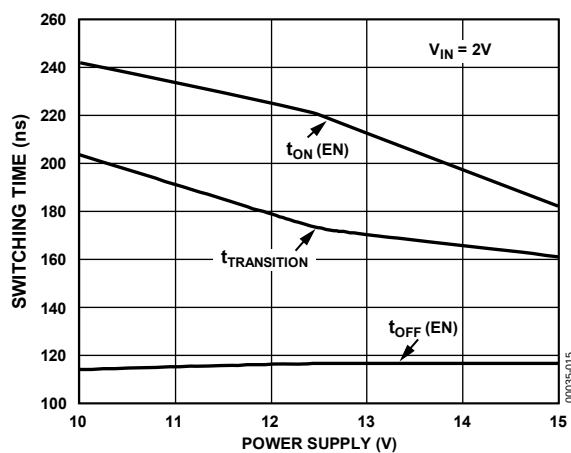


Figure 15. Switching Time vs. Power Supply

## TERMINOLOGY

**V<sub>DD</sub>**

Most Positive Power Supply Potential.

**V<sub>SS</sub>**

Most Negative Power Supply Potential.

**GND**

Ground (0 V) Reference.

**R<sub>ON</sub>**

Ohmic Resistance between D and S.

**R<sub>ON</sub> Drift**

Change in R<sub>ON</sub> when temperature changes by one degree Celsius.

**R<sub>ON</sub> Match**

Difference between the R<sub>ON</sub> of any two channels.

**I<sub>S</sub> (OFF)**

Source leakage current when the switch is off.

**I<sub>D</sub> (OFF)**

Drain leakage current when the switch is off.

**I<sub>D</sub>, I<sub>S</sub> (ON)**

Channel leakage current when the switch is on.

**V<sub>D</sub> (V<sub>S</sub>)**

Analog Voltage on Terminals D, S.

**C<sub>S</sub> (OFF)**

Channel input capacitance for off condition.

**C<sub>D</sub> (OFF)**

Channel output capacitance for off condition.

**C<sub>D</sub>, C<sub>S</sub> (ON)**

On Switch Capacitance.

**C<sub>IN</sub>**

Digital Input Capacitance.

**t<sub>ON</sub> (EN)**

Delay time between the 50% and 90% points of the digital input and switch on condition.

**t<sub>OFF</sub> (EN)**

Delay time between the 50% and 90% points of the digital input and switch off condition.

**t<sub>TRANSITION</sub>**

Delay time between the 50% and 90% points of the digital inputs and the switch on condition when switching from one address state to another.

**t<sub>OPEN</sub>**

“OFF” time measured between 80% points of both switches when switching from one address state to another.

**V<sub>INL</sub>**

Maximum input voltage for Logic 0.

**V<sub>INH</sub>**

Minimum input voltage for Logic 1.

**I<sub>INL</sub> (I<sub>INH</sub>)**

Input current of the digital input.

**Off Isolation**

A measure of unwanted signal coupling through an off channel.

**Charge Injection**

A measure of the glitch impulse transferred from the digital input to the analog output during switching.

**I<sub>DD</sub>**

Positive Supply Current.

**I<sub>SS</sub>**

Negative Supply Current.

## THEORY OF OPERATION

The ADG508F/ADG509F/ADG528F multiplexers are capable of withstanding overvoltages from  $-40\text{ V}$  to  $+55\text{ V}$ , irrespective of whether the power supplies are present or not. Each channel of the multiplexer consists of an n-channel MOSFET, a p-channel MOSFET, and an n-channel MOSFET, connected in series. When the analog input exceeds the power supplies, one of the MOSFETs will switch off, limiting the current to submicroamp levels, thereby preventing the overvoltage from damaging any circuitry following the multiplexer. Figure 17 illustrates the channel architecture that enables these multiplexers to withstand continuous overvoltages.

When an analog input of  $V_{SS} + 3\text{ V}$  to  $V_{DD} - 1.5\text{ V}$  is applied to the ADG508F/ADG509F/ADG528F, the multiplexer behaves as a standard multiplexer, with specifications similar to a standard multiplexer, for example, the on-resistance is  $400\ \Omega$  maximum. However, when an overvoltage is applied to the device, one of the three MOSFETs will turn off.

Figure 17 to Figure 20 show the conditions of the three MOSFETs for the various overvoltage situations. When the analog input applied to an ON channel approaches the positive power supply line, the n-channel MOSFET turns OFF since the voltage on the analog input exceeds the difference between  $V_{DD}$  and the n-channel threshold voltage ( $V_{TN}$ ). When a voltage more negative than  $V_{SS}$  is applied to the multiplexer, the p-channel MOSFET will turn off since the analog input is more negative than the difference between  $V_{SS}$  and the p-channel threshold voltage ( $V_{TP}$ ). Since  $V_{TN}$  is nominally  $1.5\text{ V}$  and  $V_{TP}$  is typically  $3\text{ V}$ , the analog input range to the multiplexer is limited to  $-12\text{ V}$  to  $+13.5\text{ V}$  when a  $\pm 15\text{ V}$  power supply is used.

When the power supplies are present but the channel is off, again either the p-channel MOSFET or one of the n-channel MOSFETs will turn off when an overvoltage occurs.

Finally, when the power supplies are off, the gate of each MOSFET will be at ground. A negative overvoltage switches on the first n-channel MOSFET but the bias produced by the overvoltage causes the p-channel MOSFET to remain turned off. With a positive overvoltage, the first MOSFET in the series will remain off since the gate to source voltage applied to this MOSFET is negative.

During fault conditions, the leakage current into and out of the ADG508F/ADG509F/ADG528F is limited to a few microamps. This protects the multiplexer and succeeding circuitry from over stresses as well as protecting the signal sources which drive the multiplexer. Also, the other channels of the multiplexer will be undisturbed by the overvoltage and will continue to operate normally.

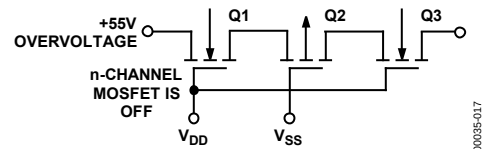


Figure 17.  $+55\text{ V}$  Overvoltage Input to the On Channel

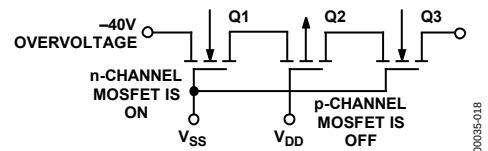


Figure 18.  $-40\text{ V}$  Overvoltage on an Off Channel with Multiplexer Power On

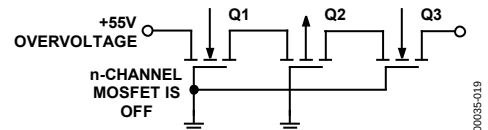


Figure 19.  $+55\text{ V}$  Overvoltage with Power Off

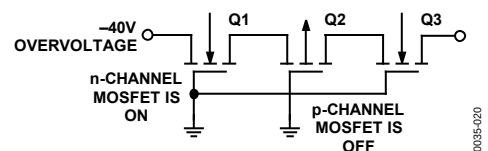
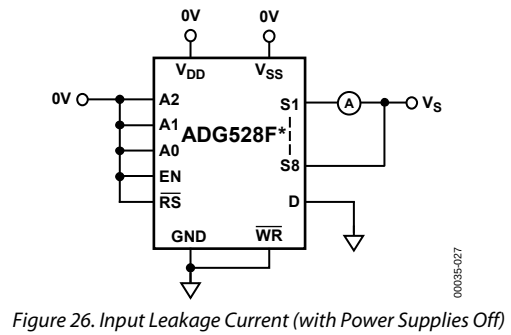
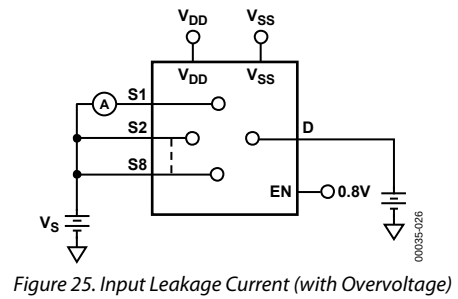
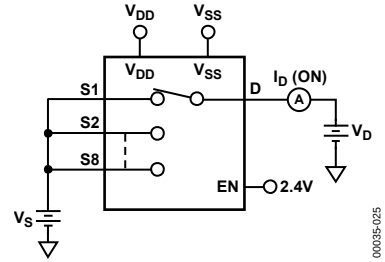
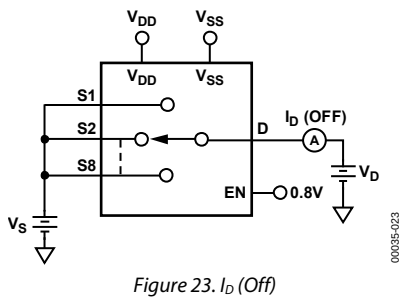
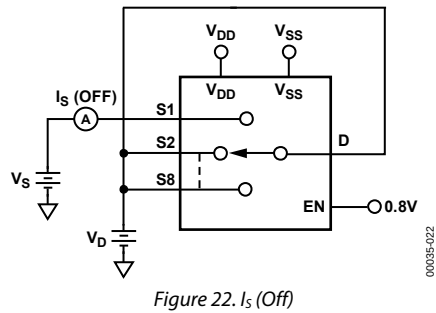
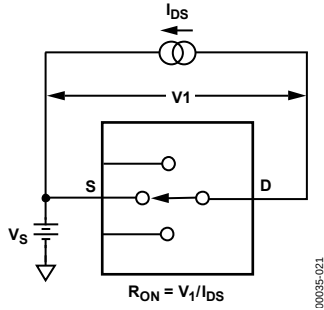


Figure 20.  $-40\text{ V}$  Overvoltage with Power Off

## TEST CIRCUITS



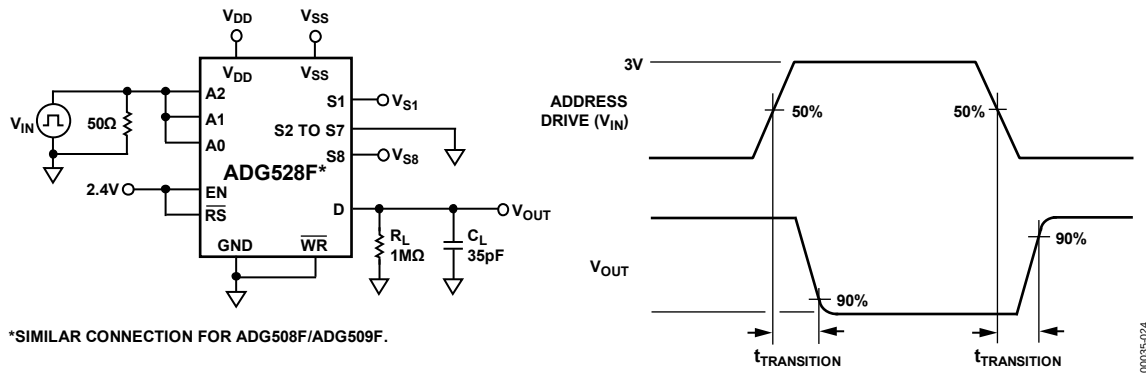


Figure 27. Switching Time of Multiplexer,  $t_{\text{TRANSITION}}$

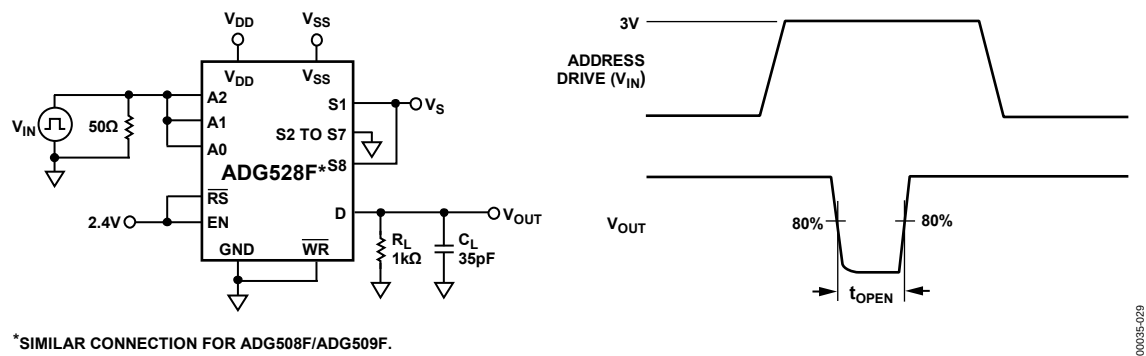


Figure 28. Break-Before-Make Delay,  $t_{\text{OPEN}}$

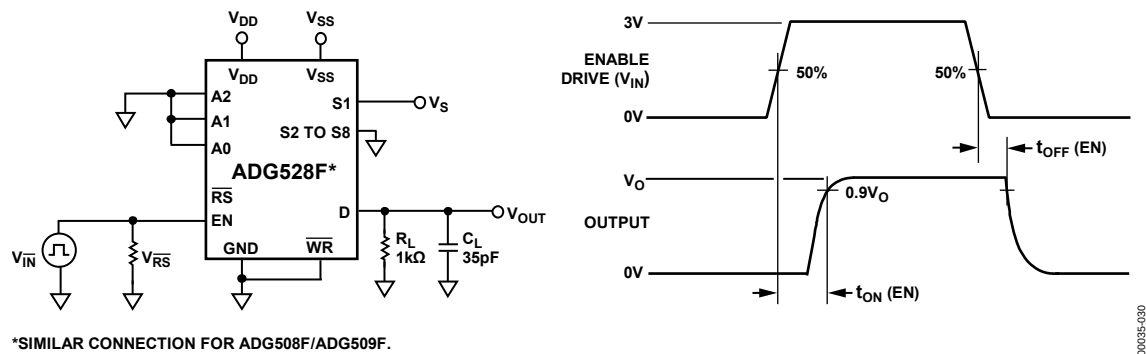


Figure 29. Enable Delay,  $t_{\text{ON}}(\text{EN})$ ,  $t_{\text{OFF}}(\text{EN})$

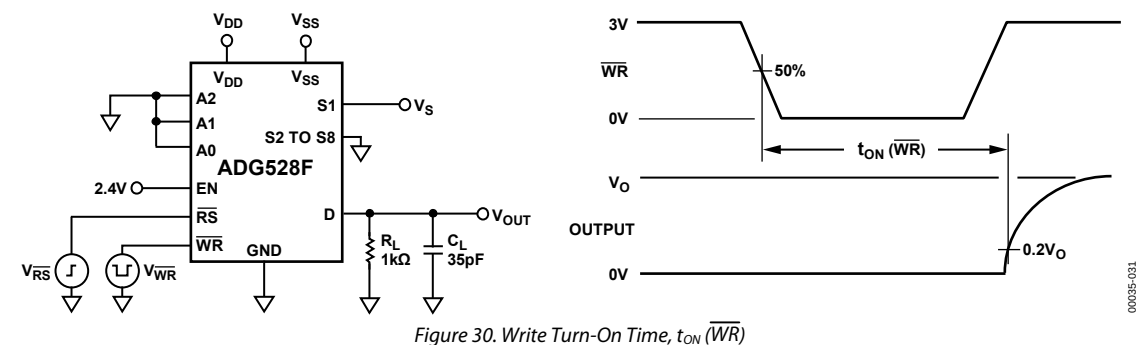
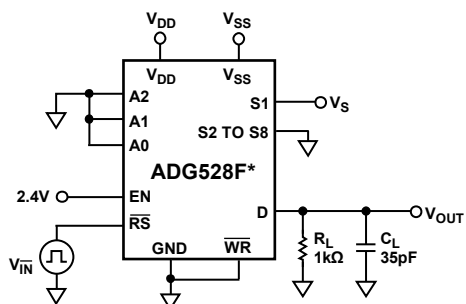
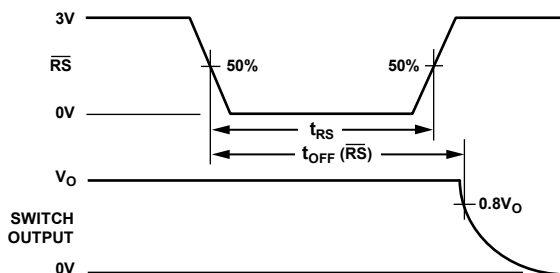


Figure 30. Write Turn-On Time,  $t_{\text{ON}}(\overline{\text{WR}})$

# ADG508F/ADG509F/ADG528F

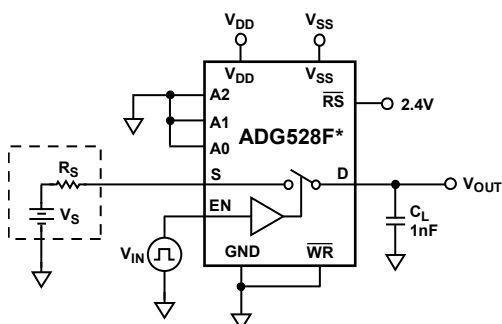


\*SIMILAR CONNECTION FOR ADG508F/ADG509F.

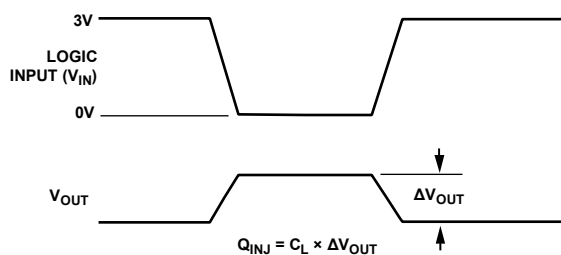


00035-032

Figure 31. Reset Turn-Off Time,  $t_{OFF}(\overline{RS})$

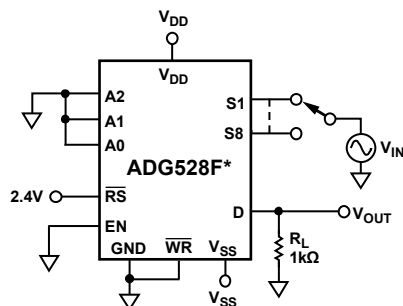


\*SIMILAR CONNECTION FOR ADG508F/ADG509F.



00035-033

Figure 32. Charge Injection

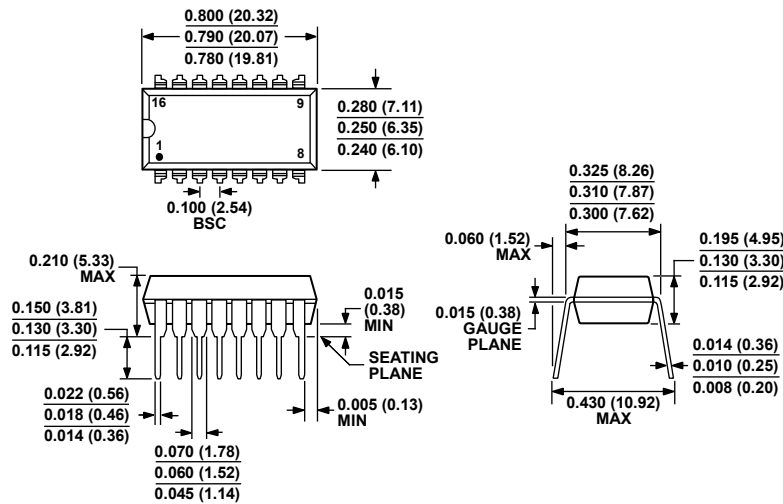


\*SIMILAR CONNECTION FOR ADG508F/ADG509F.

00035-034

Figure 33. Off Isolation

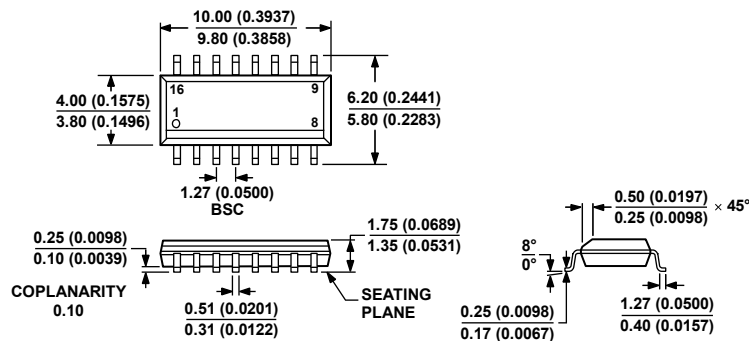
# OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-001-AB  
CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN. CORNER LEADS MAY BE CONFIGURED AS WHOLE OR HALF LEADS.

Figure 34. 16-Lead Plastic Dual In-Line Package [PDIP] Narrow Body (N-16)

Dimensions shown in inches and (millimeters)

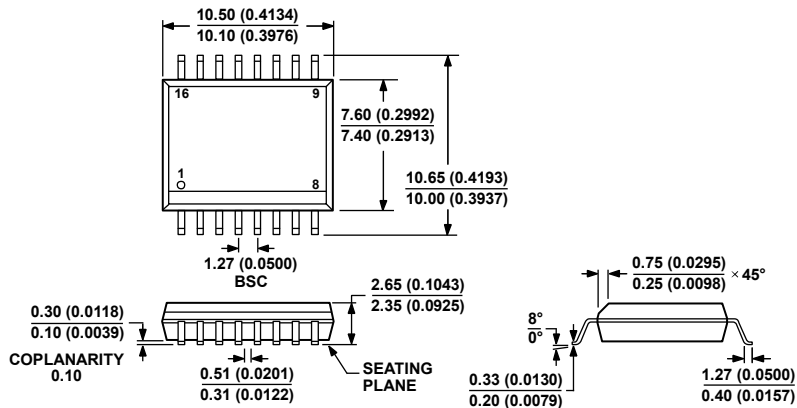


COMPLIANT TO JEDEC STANDARDS MS-012-AC  
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 35. 16-Lead Standard Small Outline Package [SOIC-N] Narrow Body (R-16)

Dimensions shown in millimeters and (inches)

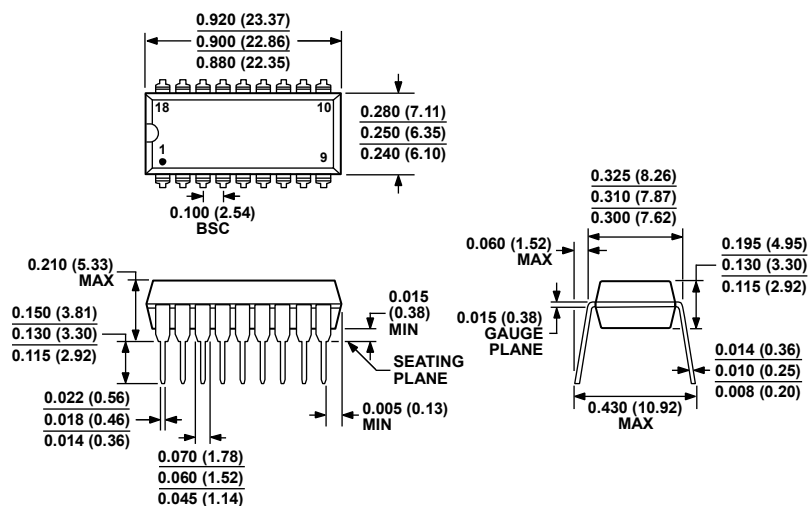
## ADG508F/ADG509F/ADG528F



COMPLIANT TO JEDEC STANDARDS MS-013-AA  
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS  
(IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR  
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 36. 16-Lead Standard Small Outline Package [SOIC-W] Wide Body  
(RW-16)

*Dimensions shown in millimeters and (inches)*

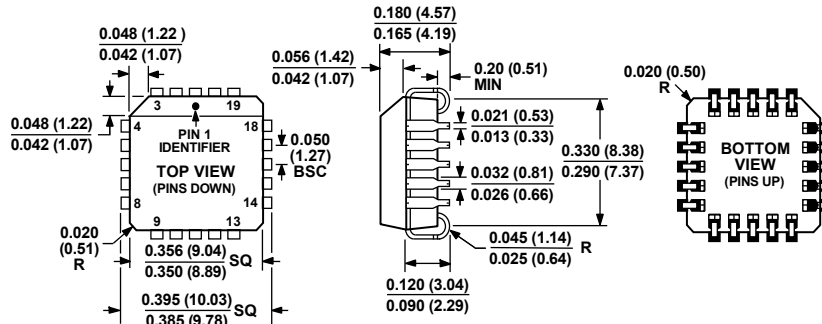


COMPLIANT TO JEDEC STANDARDS MS-001

CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN. CORNER LEADS MAY BE CONFIGURED AS WHOLE OR HALF LEADS.

*Figure 37. 18-Lead Plastic Dual In-Line Package [PDIP] Narrow Body (N-18)*

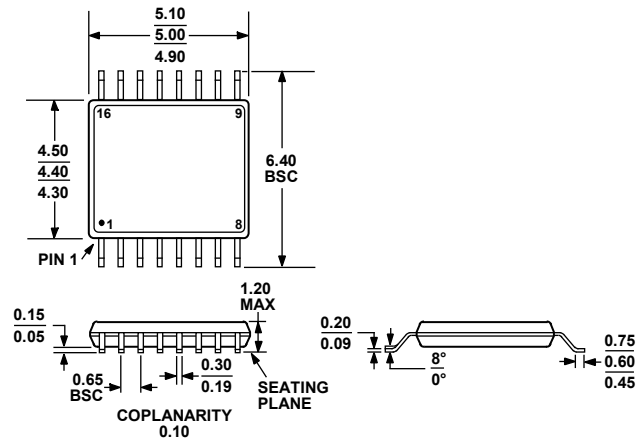
*Dimensions shown in inches and (millimeters)*



COMPLIANT TO JEDEC STANDARDS MO-047-AA  
CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS  
(IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR  
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 38. 20-Lead Plastic Leaded Chip Carrier [PLCC]  
(P-20)

Dimensions shown in inches and (millimeters)



COMPLIANT TO JEDEC STANDARDS MO-153-AB

Figure 39. 16-Lead Thin Shrink Small Outline Package [TSSOP]  
(RU-16)

Dimensions shown in millimeters

# ADG508F/ADG509F/ADG528F

## ORDERING GUIDE

| Model             | Temperature Range | Package Description | Package Option |
|-------------------|-------------------|---------------------|----------------|
| ADG508FBN         | −40°C to +85°C    | 16-Lead PDIP        | N-16           |
| ADG508FBNZ        | −40°C to +85°C    | 16-Lead PDIP        | N-16           |
| ADG508FBRN        | −40°C to +85°C    | 16-Lead SOIC_N      | R-16           |
| ADG508FBRN-REEL7  | −40°C to +85°C    | 16-Lead SOIC_N      | R-16           |
| ADG508FBRNZ       | −40°C to +85°C    | 16-Lead SOIC_N      | R-16           |
| ADG508FBRNZ-REEL7 | −40°C to +85°C    | 16-Lead SOIC_N      | R-16           |
| ADG508FBRW        | −40°C to +85°C    | 16-Lead SOIC_W      | RW-16          |
| ADG508FBRWZ       | −40°C to +85°C    | 16-Lead SOIC_W      | RW-16          |
| ADG508FBRWZ-REEL  | −40°C to +85°C    | 16-Lead SOIC_W      | RW-16          |
| ADG508FBRUZ       | −40°C to +85°C    | 16-Lead TSSOP       | RU-16          |
| ADG508FBRUZ-REEL7 | −40°C to +85°C    | 16-Lead TSSOP       | RU-16          |
| ADG509FBN         | −40°C to +85°C    | 16-Lead PDIP        | N-16           |
| ADG509FBNZ        | −40°C to +85°C    | 16-Lead PDIP        | N-16           |
| ADG509FBRN        | −40°C to +85°C    | 16-Lead SOIC_N      | R-16           |
| ADG509FBRN-REEL7  | −40°C to +85°C    | 16-Lead SOIC_N      | R-16           |
| ADG509FBRNZ       | −40°C to +85°C    | 16-Lead SOIC_N      | R-16           |
| ADG509FBRNZ-REEL7 | −40°C to +85°C    | 16-Lead SOIC_N      | R-16           |
| ADG509FBRW        | −40°C to +85°C    | 16-Lead SOIC_W      | RW-16          |
| ADG509FBRW-REEL   | −40°C to +85°C    | 16-Lead SOIC_W      | RW-16          |
| ADG509FBRWZ       | −40°C to +85°C    | 16-Lead SOIC_W      | RW-16          |
| ADG509FBRWZ-REEL  | −40°C to +85°C    | 16-Lead SOIC_W      | RW-16          |
| ADG509FBRUZ       | −40°C to +85°C    | 16-Lead TSSOP       | RU-16          |
| ADG509FBRUZ-REEL7 | −40°C to +85°C    | 16-Lead TSSOP       | RU-16          |
| ADG528FBN         | −40°C to +85°C    | 18-Lead PDIP        | N-18           |
| ADG528FBNZ        | −40°C to +85°C    | 18-Lead PDIP        | N-18           |
| ADG528FBP         | −40°C to +85°C    | 20-Lead PLCC        | P-20           |
| ADG528FBP-REEL    | −40°C to +85°C    | 20-Lead PLCC        | P-20           |
| ADG528FBPZ        | −40°C to +85°C    | 20-Lead PLCC        | P-20           |

**NOTES**

## **NOTES**

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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[www.lifeelectronics.ru](http://www.lifeelectronics.ru)